Power MOSFET

-30 V, -1.3 A, Single P-Channel, SC-70

Features

- -30 V BVds, Low RDS(on) in SC-70 Package
- Low Threshold Voltage
- Fast Switching Speed
- This is a Halide–Free Device
- This is a Pb–Free Device

Applications

- Load Switch
- Low Current Inverter and DC–DC Converters
- Power Switch for Printers, Communication Equipment

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted) Parameter Symbol Value Unit V Drain-to-Source Voltage VDSS -30 V Gate-to-Source Voltage ±12 V_{GS} $T_A = 25^{\circ}C$ -1.2 **Continuous Drain** Steady Current (Note 1) State $T_A = 85^{\circ}C$ -0.80 I_D Α T_A = 25°C t ≤ 5 s -1.3 Power Dissipation Steady 0.29 (Note 1) State $T_A = 25^{\circ}C$ PD W t ≤ 5 s 0.35 Pulsed Drain Current t_p = 10 μs -5.0 IDM Α Operating Junction and Storage Temperature T., -55 to °C 150 Tstg Source Current (Body Diode) I_S -1.0 А Lead Temperature for Soldering Purposes T_L 260 °C (1/8" from case for 10 s)

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	425	°C/W
Junction-to-Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	360	

1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces)

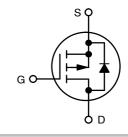


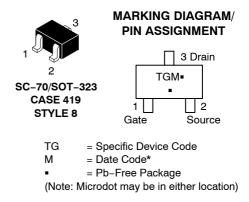
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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX		
–30 V	150 mΩ @ −10 V	–1.2 A		
	200 mΩ @ –4.5 V	–1.0 A		
	280 mΩ @ –2.5 V	–0.9 A		

SC-70/SOT-323 (3 LEADS)





ORDERING INFORMATION

Device	Package	Shipping [†]
NTS4173PT1G	SC-70 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

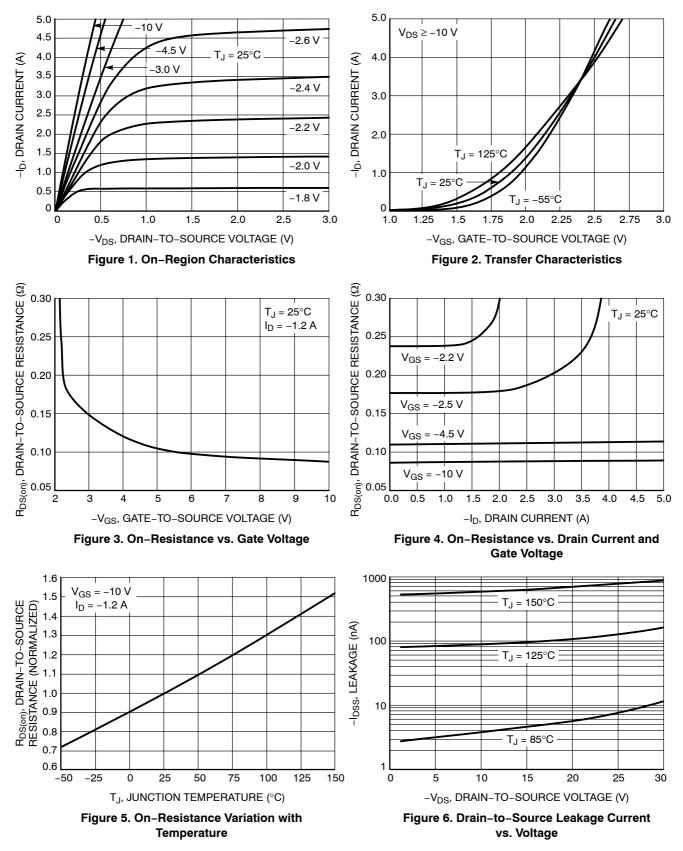
* Date code orientation may vary depending upon manufacturing location

MOSFET ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

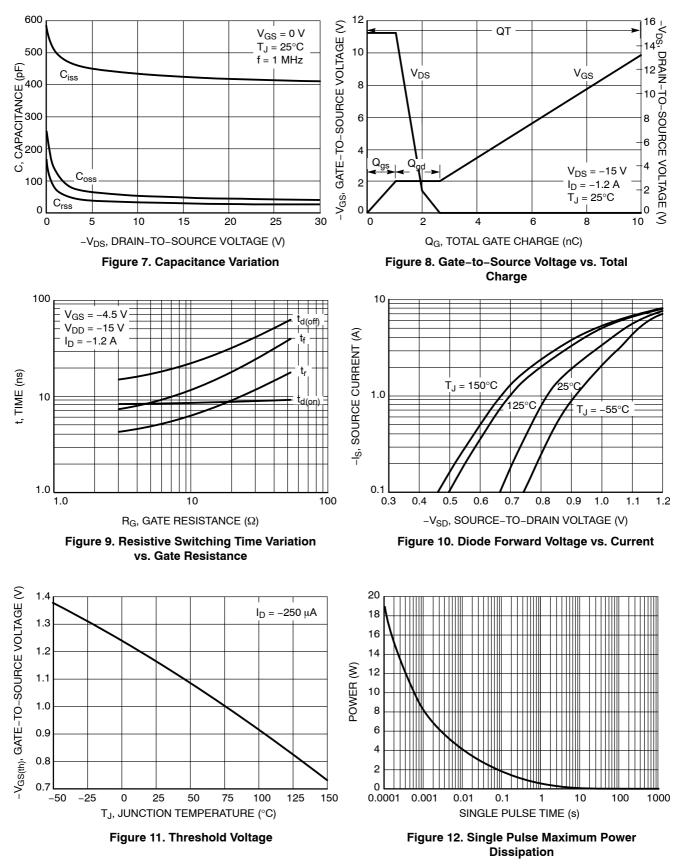
Parameter	Parameter Symbol Test Condition		Min	Тур	Max	Units
OFF CHARACTERISTICS		•				
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = -250 μ A	-30			V
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V, V_{DS} = -24 V, T_J = 25^{\circ}C$ $V_{GS} = 0 V, V_{DS} = -24 V, T_J = 85^{\circ}C$			-1.0 -5.0	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±12 V			±0.1	μA
ON CHARACTERISTICS (Note 3)	•	•				
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = -250 \ \mu A$			-1.5	V
Drain-to-Source On-Resistance	R _{DS(on)}	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -1.2 \text{ A}$		90	150	mΩ
		V _{GS} = -4.5 V, I _D = -1.0 A		110	200	-
		V_{GS} = -2.5 V, I _D = -0.9 A		165	280	1
Forward Transconductance	9 _{FS}	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -1.2 \text{ A}$		3.6		S
CHARGES, CAPACITANCES AND GA	TE RESISTA	NCE				
Input Capacitance	C _{iss}			430		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = -15 V		55		1
Reverse Transfer Capacitance	C _{rss}			40		1
Total Gate Charge	Q _{G(TOT)}			4.8		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = -4.5 V, V _{DS} = -15 V,		0.6		-
Gate-to-Source Charge	Q _{GS}	$I_{\rm D} = -1.2 \rm{A}$		1.1		
Gate-to-Drain Charge	Q _{GD}			1.5		
Total Gate Charge	Q _{G(TOT)}			10.1		nC
Threshold Gate Charge	Q _{G(TH)}	$V_{CS} = -10 V. V_{DS} = -15 V.$		0.6		1
Gate-to-Source Charge	Q _{GS}	$V_{GS} = -10 \text{ V}, V_{DS} = -15 \text{ V}, I_D = -1.2 \text{ A}$		1.1		1
Gate-to-Drain Charge	Q _{GD}			1.5		1
SWITCHING CHARACTERISTICS (No	ote 4)					
Turn-On Delay Time	t _{d(on)}			7.7		ns
Rise Time	t _r	$V_{CS} = -4.5 V_{c} V_{DS} = -15 V_{c}$		5.2		1
Turn-Off Delay Time	t _{d(off)}	$V_{GS} = -4.5 \text{ V}, \text{V}_{DS} = -15 \text{ V}, \\ \text{I}_{D} = -1.2 \text{ A}, \text{R}_{G} = 3 \Omega$		16.2		1
Fall Time	t _f			6.7		1
Turn-On Delay Time	t _{d(on)}			5.3		ns
Rise Time	t _r	$V_{CS} = -10 V_{c} V_{DS} = -15 V_{c}$		6.7		1
Turn-Off Delay Time	t _{d(off)}	V_{GS} = -10 V, V_{DS} = -15 V, I _D = -1.2 A, R _G = 3 Ω		19.9		
Fall Time	t _f			7.1		1
DRAIN-SOURCE DIODE CHARACTE	RISTICS					
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = -1.0 A -0.8		-0.8	-1.0	V
Reverse Recovery Time	t _{RR}			12		ns
Charge Time	t _a	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.0 \text{ A},$		10		1
Discharge Time	t _b	$dI_{SD}/d_t = 100 \text{ A/}\mu\text{s}$		2.0		1
Reverse Recovery Charge	Q _{RR}	1		7.0		nC

2. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces) 3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2% 4. Switching characteristics are independent of operating junction temperatures





TYPICAL CHARACTERISTICS



TYPICAL PERFORMANCE CURVES

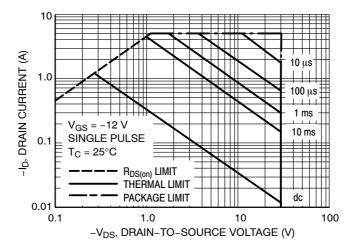
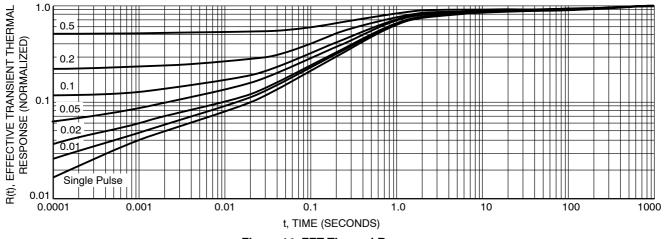


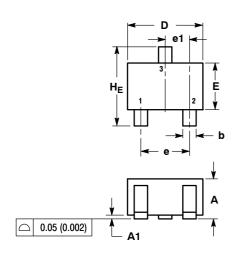
Figure 13. Maximum Rated Forward Biased Safe Operating Area





PACKAGE DIMENSIONS

SC-70 (SOT-323) CASE 419-04 ISSUE M



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

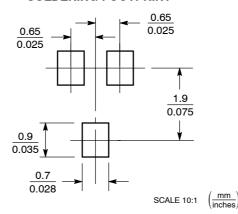
STYLE 8: PIN 1. GATE

3. DRAIN

2. SOURCE

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.7 REF			0.028 REF		
b	0.30	0.35	0.40	0.012	0.014	0.016
С	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.10	2.20	0.071	0.083	0.087
Е	1.15	1.24	1.35	0.045	0.049	0.053
e	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.425 REF			0.017 REF		
HE	2.00	2.10	2.40	0.079	0.083	0.095

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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